

Extremely low capacitance unidirectional ESD protection diode

Rev. 1 — 11 December 2012

Product data sheet

1. Product profile

1.1 General description

Extremely low capacitance unidirectional ElectroStatic Discharge (ESD) protection diode in a DSN0603-2 (SOD962) leadless ultra small Surface-Mounted Device (SMD) package designed to protect one signal line from the damage caused by ESD and other transients.

1.2 Features and benefits

- Unidirectional ESD protection of one line
- Extremely low diode capacitance C_d = 0.6 pF
- ESD protection up to ±10 kV according to IEC 61000-4-2
- Ultra low leakage current I_{RM} = 1 nA
- Ultra small SMD package

1.3 Applications

- Cellular handsets and accessories
- Portable electronics
- Communication systems
- Computers and peripherals

1.4 Quick reference data

Table 1.Quick reference data

$T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RWM}	reverse standoff voltage		-	-	5	V
C _d	diode capacitance	$f = 1 \text{ MHz}; V_R = 0 \text{ V}$	-	0.6	0.75	pF



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2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	
2	anode	1 2	1 2 006aaa 152
		Transparent top view	

[1] The marking bar indicates the cathode.

3. Ordering information

Table 3. Order	ing information		
Type number	Package		
	Name	Description	Version
PESD5V0F1USF	DSN0603-2	leadless ultra small package; 2 terminals; body 0.6 \times 0.3 \times 0.3 mm	SOD962

4. Marking

Table 4. Marking codes	
Type number	Marking code
PESD5V0F1USF	4

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

			-		
Symbol	Parameter	Conditions	Min	Мах	Unit
I _{PPM}	rated peak pulse current	$t_p = 8/20 \ \mu s$	<u>[1]</u> _	3	А
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Non-repetitive current pulse 8/20 μs exponentially decaying waveform according to IEC61000-4-5 and IEC61643-321.

Table 6.ESD maximum ratings

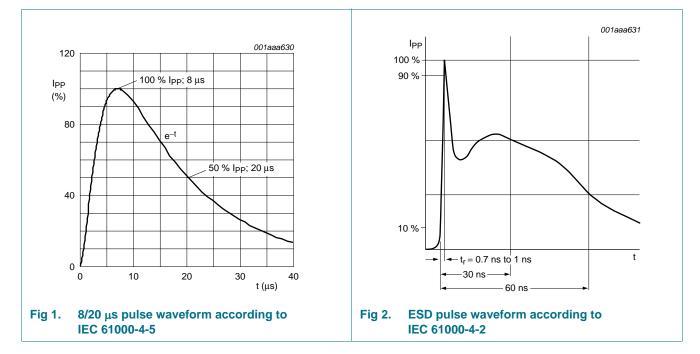
Symbol	Parameter	Conditions	ľ	Min	Max	Unit
V _{ESD} electrostatic	IEC 61000-4-2 (contact discharge)	<u>[1]</u> -		10	kV	
	discharge voltage	IEC 61000-4-2 (air discharge)	<u>[1]</u> -		10	kV
		machine model	-		400	V
		MIL-STD-883 (human body model)	-		10	kV

[1] Device stressed with ten non-repetitive ESD pulses.

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Table 7. ESD standards compliance

Standard	Conditions
IEC 61000-4-2, level 4 (ESD)	> 8 kV (contact)
MIL-STD-883; class 3B (human body model)	> 8 kV



6. Characteristics

Table 8.Characteristics

$T_{amb} = 25$	°C unless	otherwise	specified.
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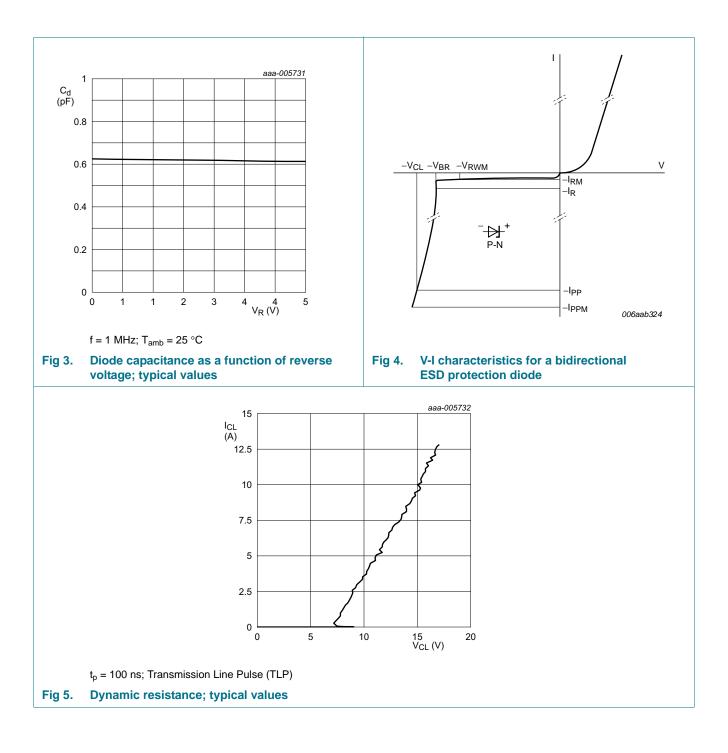
Symbol Parameter Conditions Min Typ		Unit
	_	
V _{RWM} reverse standoff voltage	5	V
I_{RM} reverse leakage $V_{RWM} = 5 V$ - 1 current	100	nA
V_{CL} clamping voltage $I_{PPM} = 3 A$ [1]	10	V
V_{BR} breakdown voltage $I_R = 5 \text{ mA}$ 6 8	10	V
C_d diode capacitance $f = 1 \text{ MHz}; V_R = 0 \text{ V}$ - 0.6	0.75	pF
r_{dyn} dynamic resistance $I_R = 10 \text{ A}$ [2] - 0.7	-	Ω

[1] Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC 61000-4-5 and IEC 61643-321.

[2] Non-repetitive current pulse, Transmission Line Pulse (TLP) t_p = 100 ns; square pulse; ANS/IESD STM5.1-2008.

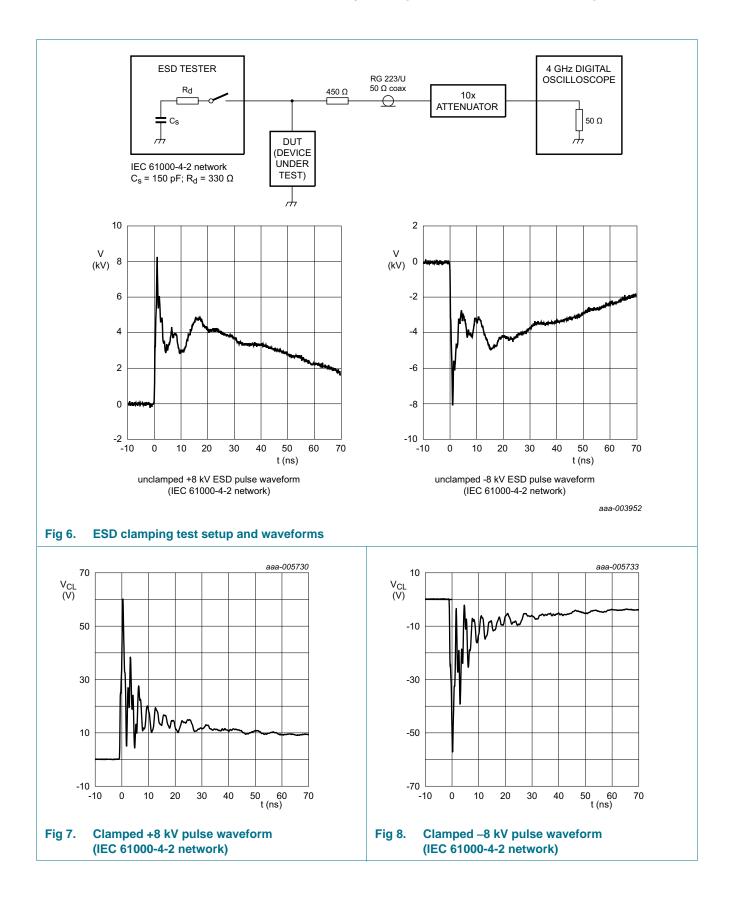
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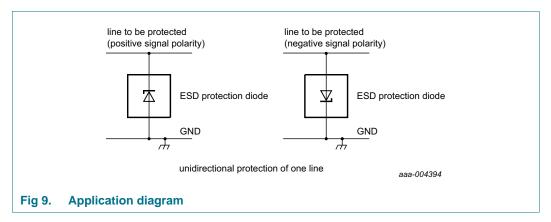
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7. Application information

The device is designed for the protection of one unidirectional data or signal line from surge pulses and ESD damage. The device is suitable on lines where the signal polarities are either positive or negative with respect to ground.



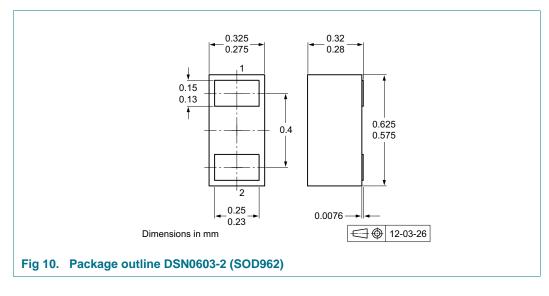
Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. Minimize the path length between the device and the protected line.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

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8. Package outline



9. Packing information

Table 9. Packing methods

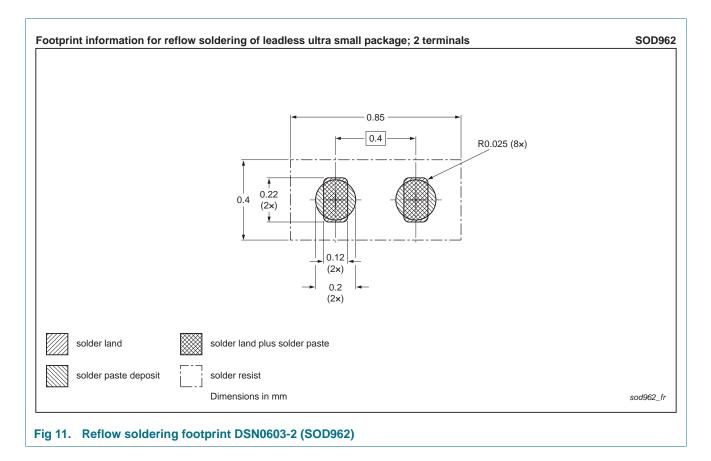
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity
			9000
PESD5V0F1USF	DSN0603-2 (SOD962)	2 mm pitch, 8 mm tape and reel	-315

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

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10. Soldering



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11. Revision history

Table 10. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
PESD5V0F1USF v.1	20121211	Product data sheet	-	-			

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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